US Micro Products
ENGINEERED DISPLAY SOLUTIONS

TFT
SPECIFICATION

Part Number	USMP-T035-032024NAS-A0
Size	3.5"
Resolution	320 x 240
Brightness	280 cd/m²
Contrast	250:1
Viewing Angle	45/50/50/50
Operating Temp.	-20 ~ 70°C

FOR ADDITIONAL INFORMATION
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Issue Date	Approved by (customer use)	Checked by	Prepared by

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
03/11/2008	0	-	New drawing	-	LIUJIN
04/24/2008	0	-	New Sample	-	LIUJIN
05/28/2008	A	-	Modify the Module's Supply Current ,Power Consumption and Uniformity	-	LIUJIN
05/30/2008	01	001	Mass Production	-	LIUJIN

Total: 26 Page

Contents

1. SPECIFICATIONS

1.1 Features

Main LCD panel

Item	Standard Value
Display Type	320(R、G、B) * 240 Dots
LCD Type	Normally white , Transmissive type
Screen size(inch)	3.5 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Backlight	LED
Interface	Digital 24-bits RGB
Other(controller/driver IC)	**Himax: HX8238-A**

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	76.9(W) * 63.9 (L) * 3.5 (H)(MAX)	mm

LCD panel

Item	Standard Value	Unit
Viewing Area	72.88 (W) * 55.36 (L)	mm
Active Area	70.08 (W) * 52.56 (L)	mm

Note : For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDDIO	VSS=0	-0.3	4.0	V
Input Voltage	VIN	-	-0.3	5.0	V
Operating Temperature	T_{OP}	-	-20	70	°C
Storage Temperature	T_{ST}	-	-30	80	°C
Storage Humidity	HD	Ta=<40°C	20	90	%RH

1.4 DC Electrical Characteristics

Module   VSS = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage1	VDDIO	-	3.0	3.3	3.6	V
V_{COM} High Voltage	V_{COMH}	-	-	-	5.54	V
V_{COM} Low Voltage	V_{COML}	-	-2.8	-	-	V
Input High Voltage	VIH	-	0.8×VDDIO	-	VDDIO	V
Input Low Voltage	VIL	-	0	-	0.2×VDDIO	V
Output High Voltage	VOH	-	0.9×VDDIO	-	VDDIO	V
Output Low Voltage	VOL	-	-	-	0.1×VDDIO	V
Supply Current	IDD	VDDIO=3.3 V Pattern=full display	-	7.6	-	mA
		VDDIO=3.3 V Pattern= black *1	-	8.5	13	mA
Power Consumption	PW	-	-	28.1	-	mW

Note1:Maximum current display

1.5 Optical Characteristics

TFT LCD Module VDDIO=3.3V, Ta=25°C

| Item		Symbol	Condition	Min.	Typ.	Max.	unit	-
Response time		Tr+ Tf	Ta = 25°C θX, θY = 0°	-	35	53	ms	Note2
Viewing angle	Top	θY+	CR ≥ 10	-	45	-	Deg.	Note4
	Bottom	θY-		-	50	-		
	Left	θX-		-	50	-		
	Right	θX+		-	50	-		
Contrast ratio		CR		200	250	-	-	Note3
Color of CIE Coordinate (With B/L)	White	X	Ta = 25°C θX , θY = 0°	0.24	0.29	0.34	-	Note1
		Y		0.26	0.31	0.36		
	Red	X		0.57	0.62	0.67		
		Y		0.31	0.36	0.41		
	Green	X		0.27	0.32	0.37		
		Y		0.56	0.61	0.66		
	Blue	X		0.09	0.14	0.19		
		Y		0.03	0.08	0.13		
Average Brightness Pattern=white display (With B/L) *1		IV	IF=20 mA	240	280	-	cd/m^2	
Uniformity (With B/L)*1		△B	IF=20 mA	70	-	-	%	

Note1:

1： △B=B(min) / B(max)

2：Measurement Condition for Optical Characteristics:3：

　　a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp

　　　current and typical operating frequency.

　　b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)

　　c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.

　　d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%

Colorimeter=BM 7 fast
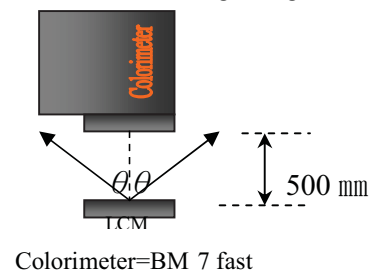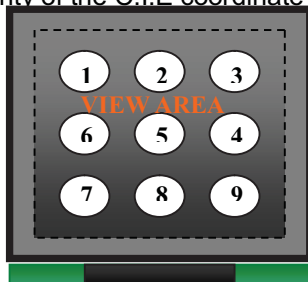
Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.
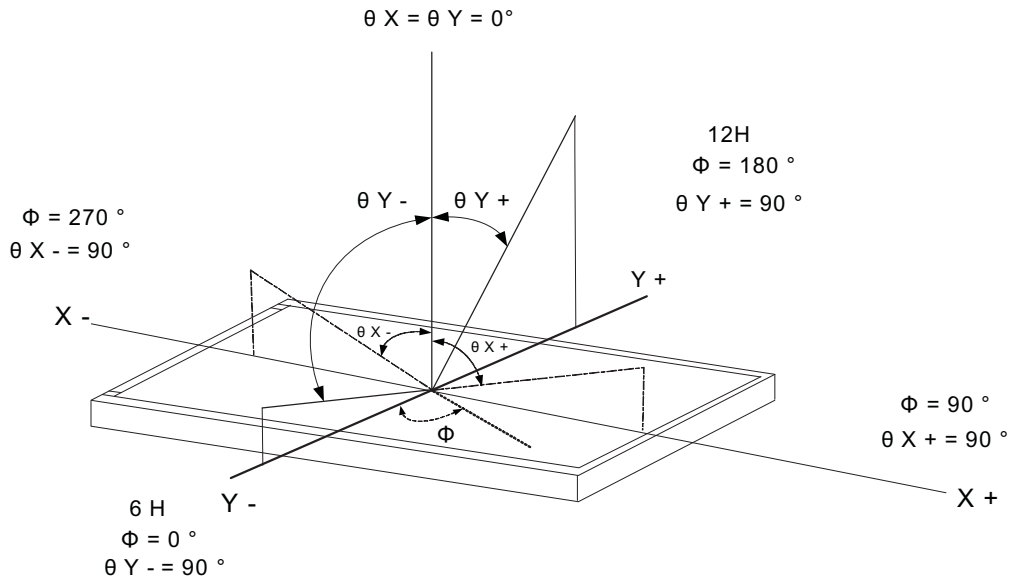
Refer to figure as below:
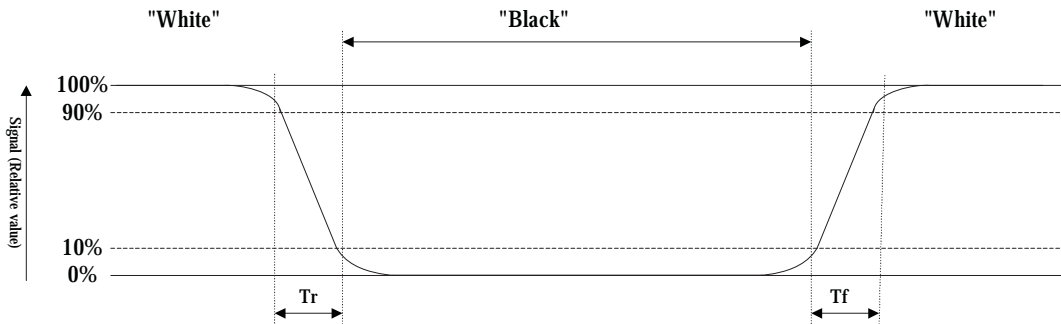
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector output when LCD is at "Black" state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:

1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25℃	-	30	mA
Reverse Voltage	VR	Ta =25℃	-	30	V
Forward Voltage	VF	Ta =25℃	-	24	V
Power Dissipation	PD	Ta =25℃	-	720	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF		18.6	19.8	21.6	V
Average Brightness (without LCD)	IV	IF= 20 mA	3500	4300	-	cd/m^2
CIE Color Coordinate (Without LCD)	X		-	0.29	-	-
	Y		-	0.29	-	
Color	White					

VBL+ （+）

VBL- （-）
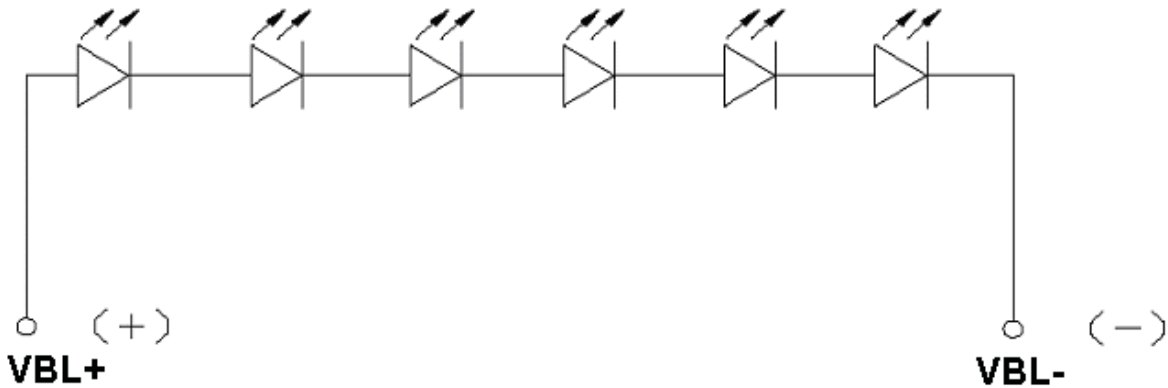
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram
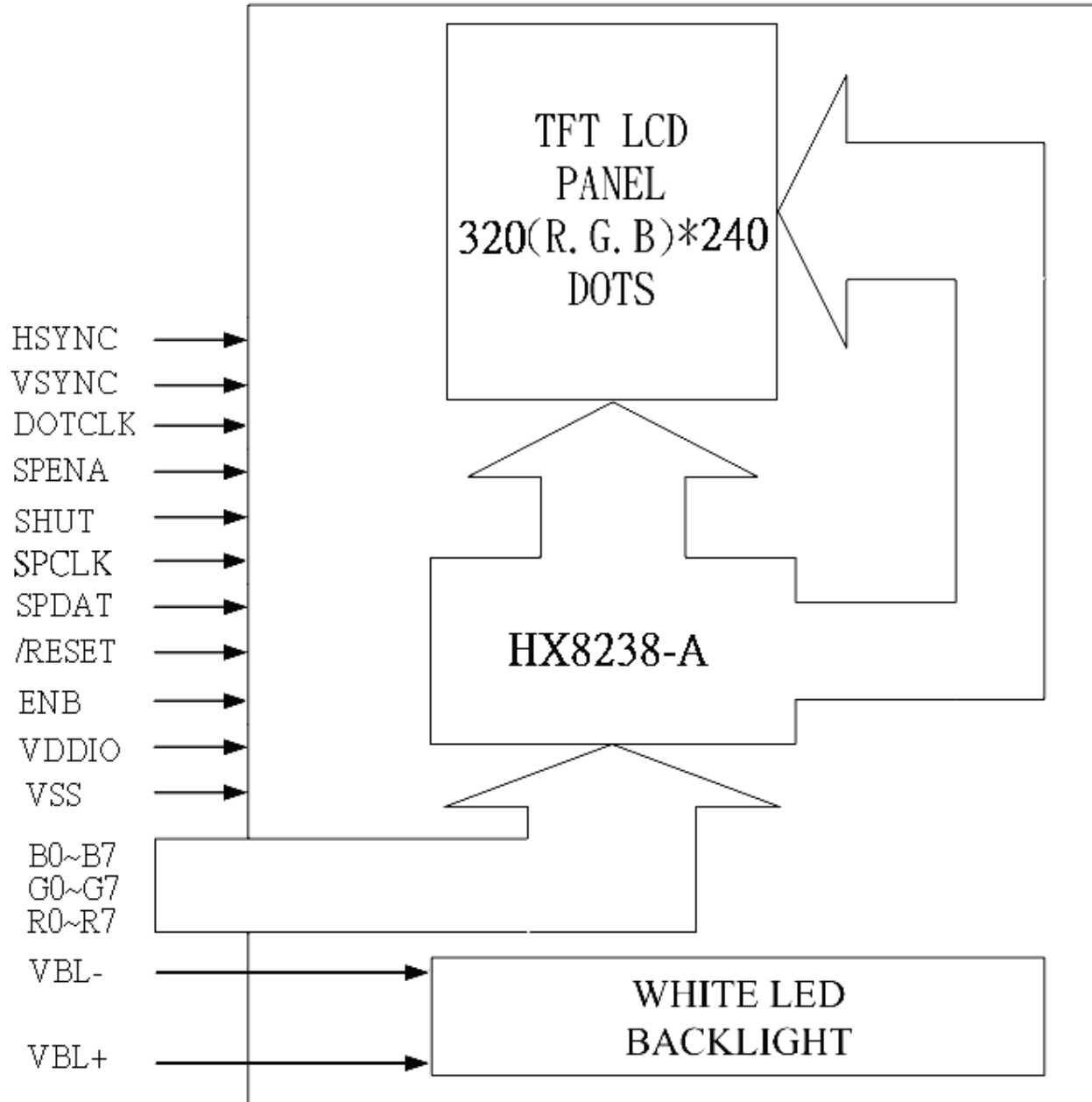
2.2 Interface Pin Description
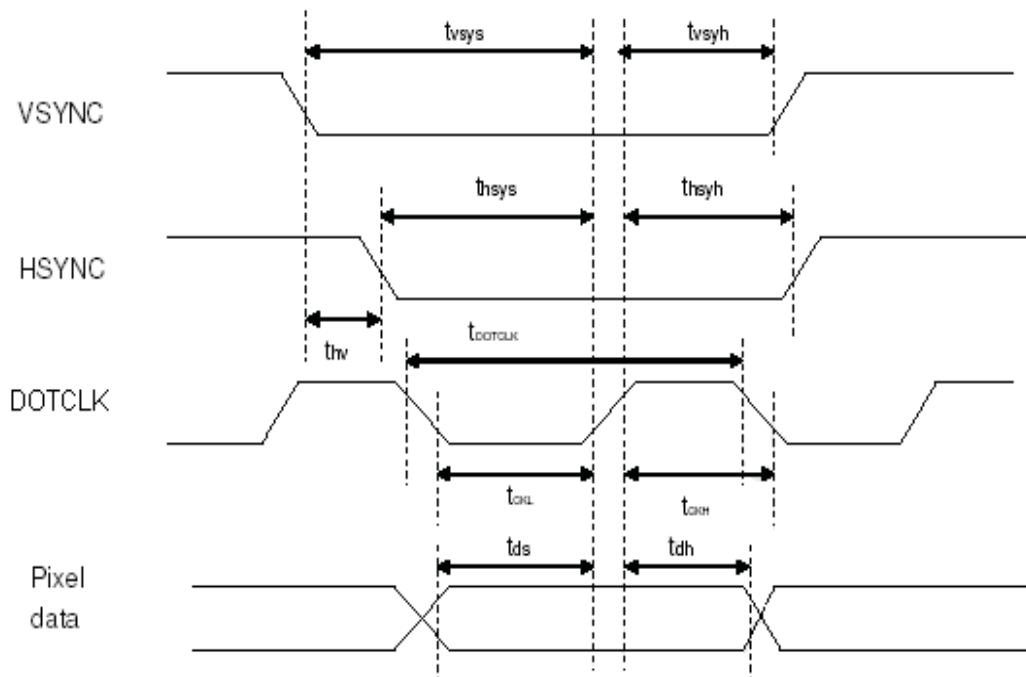
Pin No.	Symbol	Function
1	VBL-	Power supply for LED Backlight cathode input
2	VBL-	Power supply for LED Backlight cathode input
3	VBL+	Power supply for LED Backlight anode input
4	VBL+	Power supply for LED Backlight anode input
5	NC	Not used , Must be open
6	/RESET	Hardware reset
7	NC	Not used , Must be open. (Output Pin ,POL output.)
8	Y1	Not used
9	X1	Not used
10	Y2	Not used
11	X2	Not used
12	B0	Blue data bit 0
13	B1	Blue data bit 1
14	B2	Blue data bit 2
15	B3	Blue data bit 3
16	B4	Blue data bit 4
17	B5	Blue data bit 5
18	B6	Blue data bit 6
19	B7	Blue data bit 7
20	G0	Green data bit 0
21	G1	Green data bit 1
22	G2	Green data bit 2
23	G3	Green data bit 3
24	G4	Green data bit 4
25	G5	Green data bit 5
26	G6	Green data bit 6
27	G7	Green data bit 7
28	R0	Red data bit 0
29	R1	Red data bit 1
30	R2	Red data bit 2

31	R3	Red data bit 3
32	R4	Red data bit 4
33	R5	Red data bit 5
34	R6	Red data bit 6
35	R7	Red data bit 7
36	HSYNC	Horizontal sync input
37	VSYNC	Vertical sync input
38	DOTCLK	Dot data clock
39	VDDIO	Digital power
40	VDDIO	Digital power
41	VDDIO	Digital power
42	VDDIO	Digital power
43	SPENA	Serial port data enable signal
44	NC	Not used , Must be open
45	NC	Not used , Must be open (Output Pin ,V_{GL} ,Gate off power.)
46	NC	Not used , Must be open
47	NC	Not used , Must be open (Output Pin ,V_{GH}, Gate on power.)
48	SHUT	Display shut down pin to put the driver into sleep mode. A sharp falling edge must be provided to such pin when IC power on. Internal pull low. - Connect to VDDIO for sleep mode - Connect to VSS for normal operating mode (Refer to Power Up Sequence)
49	SPCLK	Serial data clock
50	SPDAT	Serial data
51	NC	Not used , Must be open (Output Pin ,VCOM power.)
52	ENB	Data enable control
53	VSS	Ground
54	VSS	Ground

2.3 Timing Characteristics

Pixel timing

Characteristics	Symbol	Min		Typ		Max		Unit
		24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	
DOTCLK Frequency	fDOTCLK	-		6.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3	-		ns
Vertical Sync Setup Time	tvsys	20	10	-		-		ns
Vertical Sync Hold Time	tvsyh	20	10	-		-		ns
Horizontal Sync Setup Time	thsys	20	10	-		-		ns
Horizontal Sync Hold Time	thsyh	20	10	-		-		ns
Phase difference of Sync Signal Falling Edge	thv	1		-		240		tDOTCLK
DOTCLK Low Period	tCKL	50	15	-		-		ns
DOTCLK High Period	tCKH	50	15	-		-		ns
Data Setup Time	tds	12	10	-		-		ns
Data hold Time	tdh	12	10	-		-		ns
Reset pulse width	tRES	10		-		-		us

Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal.

Pixel timing

Note：The interface of this module can drive by digital 24-bit data.

$H_{cycle} = 408$

$t_{HBP} = 68$ $H_{DISP} = 320$ $t_{HFP} = 20$

DOTCLK

HSYNC

Pixel Data

Dummy | D0 | D1 | ---------- | D318 | D319 | D320 | Dummy
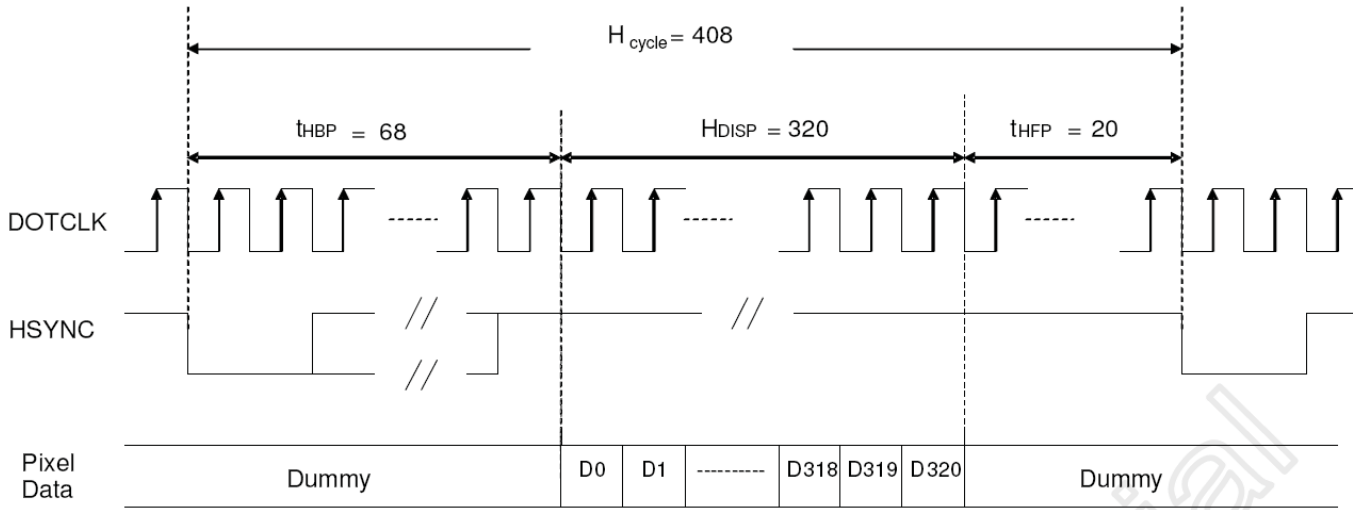
a) Horizontal Data Transaction Timing

$V_{cycle} = 262$ Lines

$t_{VBP} = 18$

VSYNC

$V_{DISP} = 240$ Lines $t_{VFP} = 4$

HSYNC

Line 0   Line 239
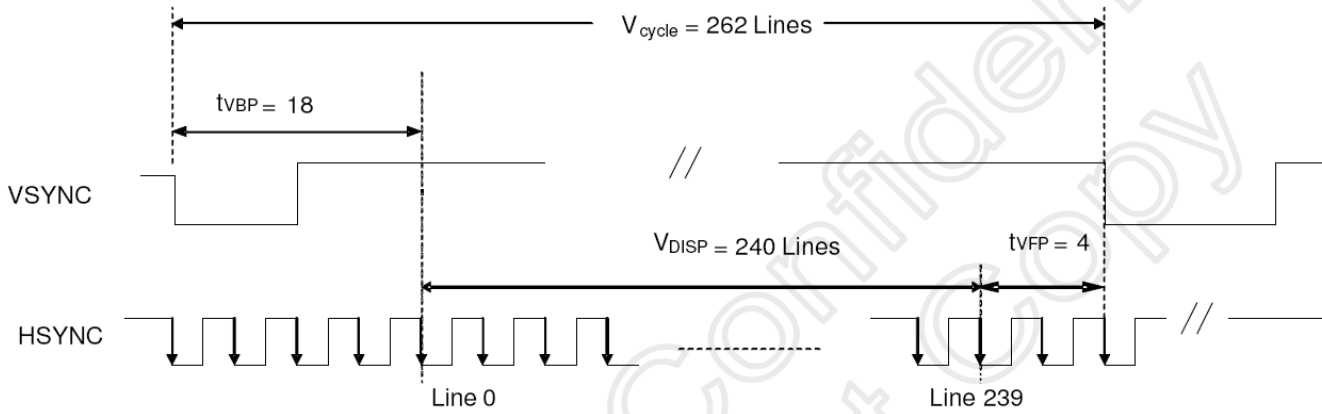
b) Vertical Data Transaction Timing

Data transaction timing in parallel RGB(24 bit)interface (SYNC mode)

2.4 Power Sequence
2.4.1 Power up sequence
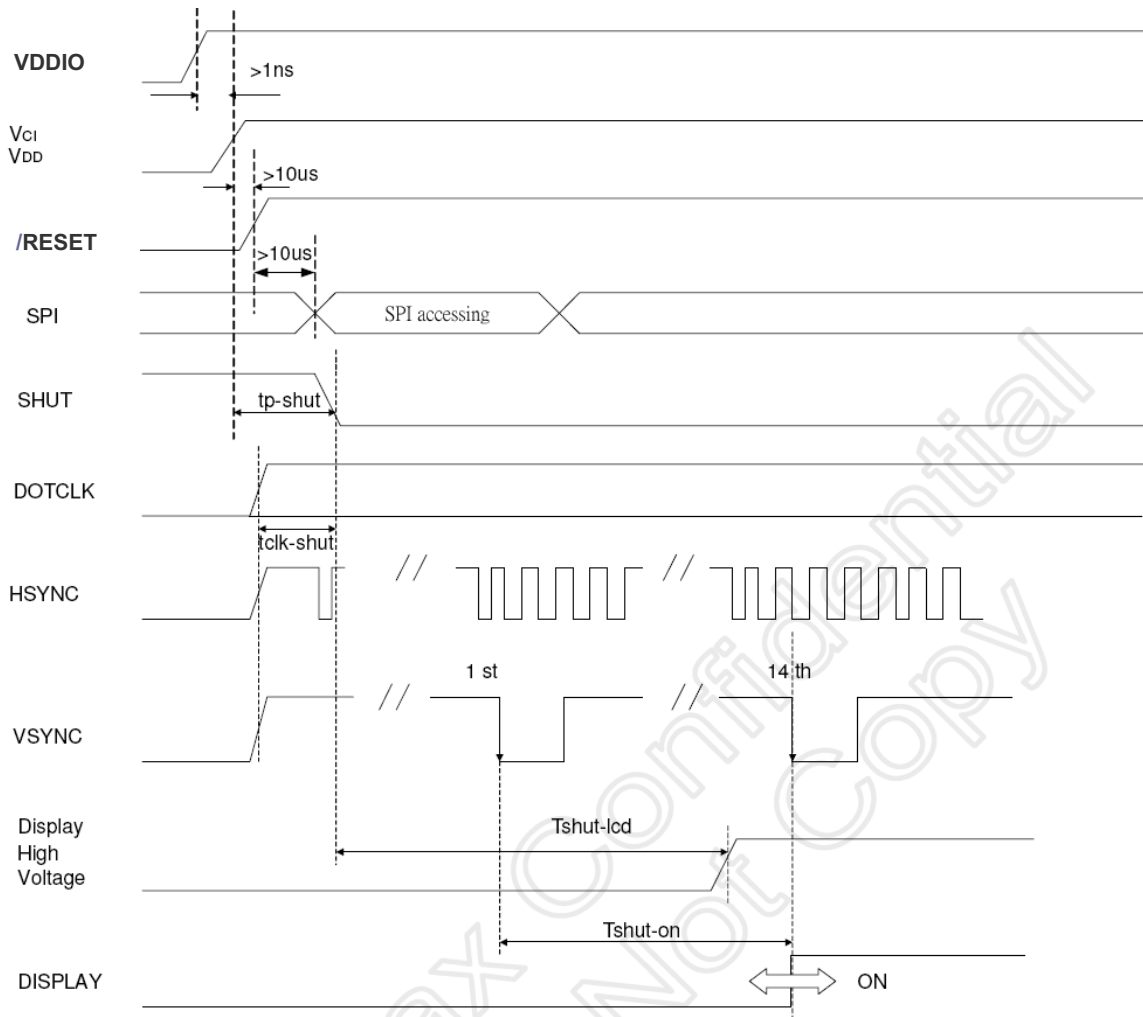
Characteristics	Symbol	Min	Typ	Max	Units
VDDD / VDDIO on to falling edge of SHUT	tp-shut	1	-	-	us
DOTCLK	tclk-shut	1	-	-	clk
Falling edge of SHUT to LCD power on	tshut-lcd	-	-	128	ms
Falling edge of SHUT to display start - 1 line: 408 clk - 1 frame: 262 line -DOTCLK = 6.5MHz	tshut-on	-	-	14	frame
		-	166	232.4	ms

Note: It is necessary to input DOTCLK before the falling edge of SHUT.
Display starts at 10th falling edge of VSTNC after the falling edge of SHUT.

2.4.2 Power down sequence
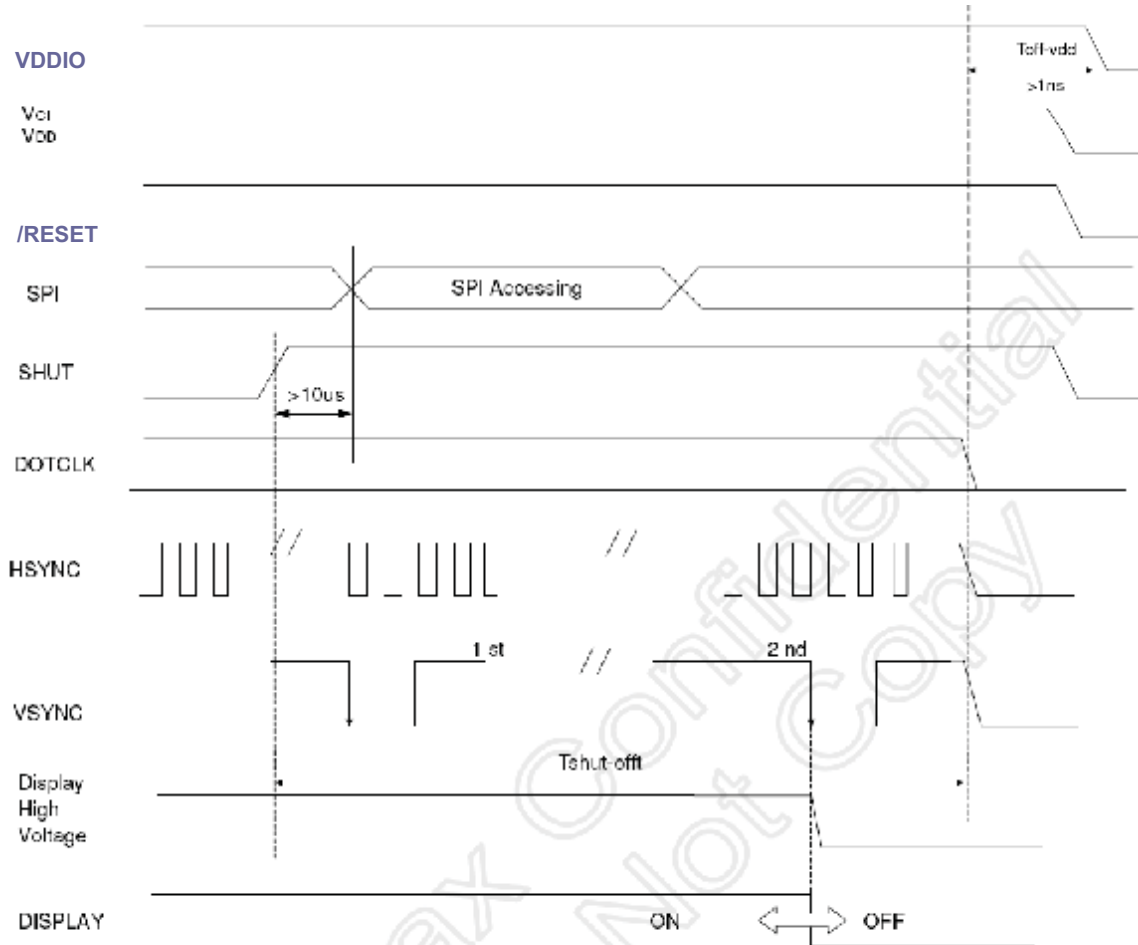
Characteristics	Symbol	Min	Typ	Max	Uni
Rising edge of SHUT to display off	tshut-off	2	-	-	frame
- 1 line: 408 clk - 1 frame: 262 line - DOTCLK = 6.5MHz		33.4	-	-	ms
Input-signal-off to VDDD / VDDIO off	toff-vdd	1	-	-	us

Note: DOTCLK must be maintained at lease 2 frames after the rising edge of SHUT.

Display become off at the 2nd falling edge of VSTNC after the falling edge of SHUT.

If RESET signal is necessary for power down, provide it after the 2-frames-cycle of the SHUT period.

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart

Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Marketing & Design	Info → Survey; Request → Inquiry		Project evaluation; Project Validation (NG / OK); Quote; Contract					
Sample Approval			Design check; Sample test; Verification (NG / OK); Sample approval (NG)					OK
Pilot Run & Mass Product			Pilot run & Reliability test; Verification (NG / OK); Specification preparation; Mass production; Inspection (OK / NG)					
Ship Out	Shipment							Ship out

Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

```
┌──────┐    ┌───────┐
│ Info │ ─> │ Claim │ ──────────────────────┐
└──────┘    └───────┘                        v
                    ┌──────────────────────────────────┐
                    │          Failure analysis         │
                    └──────────────────────────────────┘
        ┌───────────────────┐                  │
        │  Analysis report  │                  v
        └───────────────────┘    ┌──────────────────────────┐
                                 │     Corrective action     │
                                 └──────────────────────────┘
                    ┌──────────┐                │
                    │ Tracking │ <──────────────┘
                    └──────────┘
```

3.2   Inspection Specification

1. Inspection Specification

◆Scope   : The document shall be applied to TFT-LCD Module for 3. 5″ ~10″ (Ver. 02).

◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge、MIL-STD、Sample

◆Defect Level : Major Defect   AQL : 0. 4 ;   Minor Defect   AQL : 1.5

◆OUT Going Defect Level : Sampling.

◆Standard of the product appearance test :

a. Manner of appearance test :

(1). The test best be under 20W×2 fluorescent light : and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.
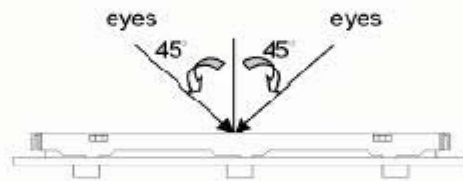
(3). Definition of area.
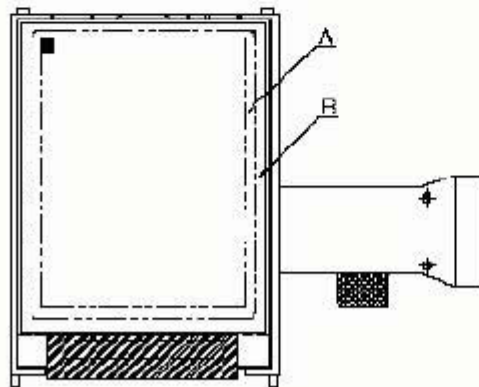
A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection :   (Unit : mm)
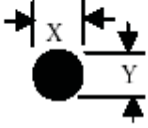
◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver. 02)

NO	Item	Criterion	Level
01	Product condition	1.1 The part number is inconsistent with work order of production.	Major
		1.2 Mixed product types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.	Major
04	Electrical Testing	4.1 Missing line character and icon.	Major
		4.2 No function or no display.	Major
		4.3 Display malfunction.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
05	Dot defect (Bright dot、Dark dot) On -display	<table><tr><td colspan="2">Item</td><td>Acceptance (Q'ty)</td></tr><tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 4</td></tr><tr><td>Dark Dot</td><td>≦ 5</td></tr><tr><td>Joint Dot</td><td>≦ 3</td></tr><tr><td>Total</td><td>≦ 7</td></tr></table> 5.1 Inspection pattern：full white , full black , Red , Green and blue screens. 5.2 It is defined as dot defect if defect area ＞1/2 dot. 5.3 The distance between two dot defect ≧5 mm.	Minor
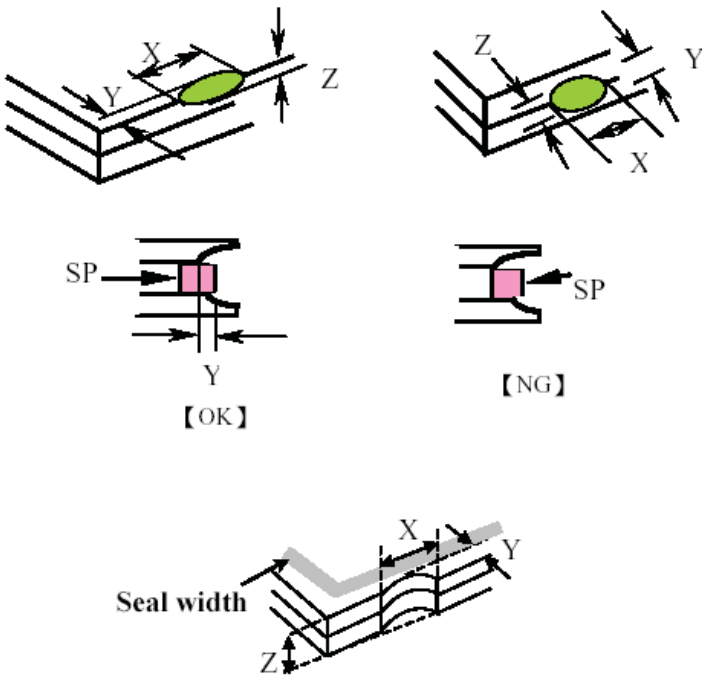
◆Specification For TFT-LCD Module 3.5″ ~10″ :　　　　　　　　　　　　　　　　　　　(Ver. 02)

NO	Item	Criterion	Level
06	**Black or white dot、scratch、contamination** **Round type** X Y $\Phi=(x+y)/2$ **Line type** W L	6.1 Round type (Non-display or display) ： <table><tr><td>Dimension (diameter：Φ)</td><td>Acceptance (Q'ty)</td></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td></tr><tr><td>0.25 ＜ Φ ≦ 0.50</td><td>5</td></tr><tr><td>Φ ＞ 0.50</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table> 6.2 Line type(Non-display or display) ： <table><tr><td>Length (L)</td><td>Width (W)</td><td>Acceptance (Q'ty)</td></tr><tr><td>---</td><td>W ≦ 0.03</td><td>Ignore</td></tr><tr><td>L ≦10.0</td><td>0.03 ＜ W ≦ 0.05</td><td>4</td></tr><tr><td>L ≦5.0</td><td>0.05 ＜ W ≦ 0.10</td><td>2</td></tr><tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr><tr><td>Total</td><td></td><td>5</td></tr></table>	Minor
07	**Polarizer Bubble**	<table><tr><td>Dimension (diameter：Φ)</td><td>Acceptance (Q'ty)</td></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td></tr><tr><td>0.25 ＜ Φ ≦ 0.50</td><td>4</td></tr><tr><td>0.50 ＜ Φ ≦ 0.80</td><td>1</td></tr><tr><td>Φ ＞ 0.80</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table>	Minor

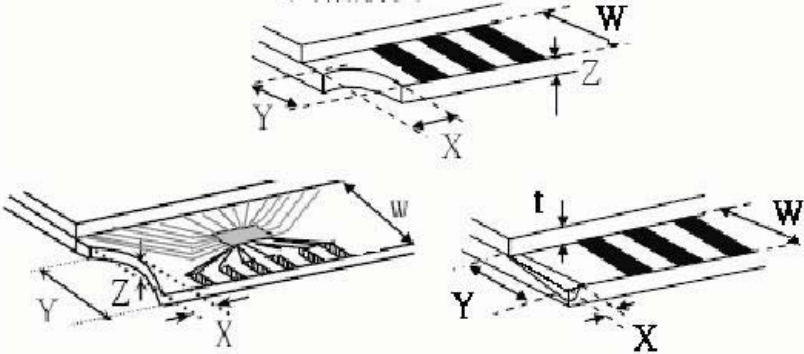| NO	Item	Criterion	Level
08	The crack of glass	**Symbols**： X : The length of crack　　　　Y : The width of crack. Z : The thickness of crack　　W : terminal length t : The thickness of glass　　a : LCD side length **8.1 General glass chip**： **8.1.1 Chip on panel surface and crack between panels:** 【OK】　　　　　　【NG】 Seal width <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≦ a</td><td>Crack can't enter viewing area</td><td>≦1/2 t</td></tr><tr><td>≦ a</td><td>Crack can't exceed the half of SP width.</td><td>1/2 t < Z ≦2 t</td></tr></table>	Minor
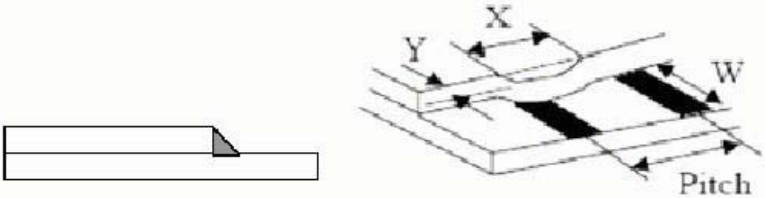
NO	Item	Criterion	Level
08	The crack of glass	**Symbols：** X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length **8.1.2 Corner crack：** <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≦1/5 a</td><td>Crack can't enter viewing area</td><td>Z ≦ 1/2 t</td></tr><tr><td>≦1/5 a</td><td>Crack can't exceed the half of SP width.</td><td>1/2 t < Z ≦ 2 t</td></tr></table> **8.2 Protrusion over terminal：** **8.2.1 Chip on electrode pad：** <table><tr><td></td><td>X</td><td>Y</td><td>Z</td></tr><tr><td>Front</td><td>≦ a</td><td>≦ 1/2 W</td><td>≦ t</td></tr><tr><td>Back</td><td>≦ a</td><td>≦ W</td><td>≦ 1/2 t</td></tr></table>	Minor

◆**Specification For TFT-LCD Module 3.5″ ~10″ :** (Ver. 02)

NO	Item	Criterion	Level
08	The crack of glass	**Symbols :** X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length **8.2.2 Non-conductive portion :** <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≦ 1/3 a</td><td>≦ W</td><td>≦t</td></tr></table> ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8.2.3 Glass remain : <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>≦ a</td><td>≦ 1/3 W</td><td>≦t</td></tr></table>	Minor

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver. 02)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type、quantity、dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≦1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION	
1	**High Temperature Storage Test**	**Keep in** +80 ±2℃ 96 **hrs** **Surrounding temperature, then storage at normal condition** 4**hrs.**	
2	**Low Temperature Storage Test**	**Keep in** -30 ±2℃ 96 **hrs** **Surrounding temperature, then storage at normal condition** 4**hrs.**	
3	**High Temperature / High Humidity Storage Test**	**Keep in** +60℃ / 90% **R.H duration for** 96 **hrs** **Surrounding temperature, then storage at normal condition** 4**hrs.** **(Excluding the polarizer)**	
4	**ESD Test**	**Air Discharge:** **Apply** 2 **KV with** 5 **times** **Discharge for each polarity +/-**	**Contact Discharge:** **Apply** 250 **V with** 5 **times** **discharge for each polarity +/-**
		1. **Temperature ambiance :** 15℃～35℃ 2. **Humidity relative :** 30%～60% 3. **Energy Storage Capacitance(Cs+Cd) :** 150pF±10% 4. **Discharge Resistance(Rd) :** 330Ω±10% 5. **Discharge, mode of operation :** **Single Discharge (time between successive discharges at least** **1 sec)** **(Tolerance if the output voltage indication :** ±5%**)**	
5	**Temperature Cycling Storage Test**	-20℃ → +25℃ → +70℃ → +25℃ (30**mins**) (5**mins**) (30**mins**) (5**mins**) ←————— 10 **Cycle** —————→ **Surrounding temperature, then storage at normal condition** 4**hrs.**	
6	**Vibration Test (Packaged)**	1. **Sine wave** 10～55 **Hz frequency (1 min)** 2. **The amplitude of vibration :** 1.5 **mm** 3. **Each direction (X、Y、Z) duration for** 2 **Hrs**	
7	**Drop Test (Packaged)**	<table><tr><td>**Packing Weight (Kg)**</td><td>**Drop Height (cm)**</td></tr><tr><td>0 ~ 45.4</td><td>122</td></tr><tr><td>45.4 ~ 90.8</td><td>76</td></tr><tr><td>90.8 ~ 454</td><td>61</td></tr><tr><td>Over 454</td><td>46</td></tr></table> **Drop direction :**※**1 corner / 3 edges / 6 sides each** 1**times**	

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1   If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2   If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.
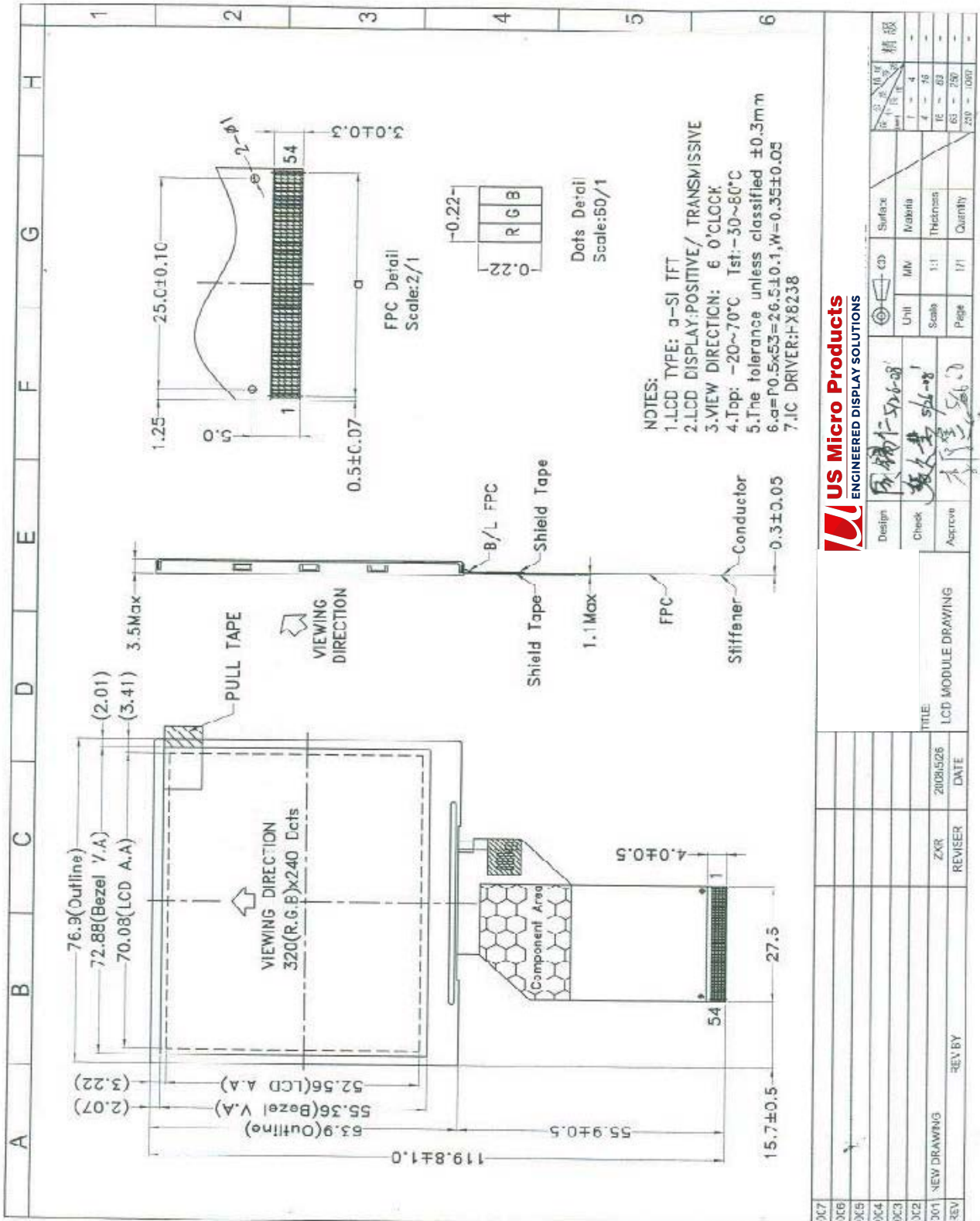
5.2 HANDLING

5.2.1   Avoid any strong mechanical shock which can break the glass.

5.2.2   Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3   Do not remove the panel or frame from the module.

5.2.4   The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5   Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6   Do not touch the display area with bare hands , this will stain the display area.

5.2.7   Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8   To control temperature and time of soldering is 320±10℃ and 3-5 sec.

5.2.9   To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

5.3.1   Store the panel or module in a dark place where the temperature is 25℃ ±5℃ and the humidity is below 65% RH.

5.3.2   Do not place the module near organics solvents or corrosive gases.

5.3.3   Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1   Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2   Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

US Micro Products
ENGINEERED DISPLAY SOLUTIONS

NOTES:
1.LCD TYPE: a-SI TFT
2.LCD DISPLAY:POSITIVE/ TRANSMISSIVE
3.VIEW DIRECTION: 6 O'CLOCK
4.Top: -20~70°C Tst:-30~80°C
5.The tolerance unless classified ±0.3mm
6.a=P0.5x53=26.5±0.1,W=0.35±0.05
7.IC DRIVER:H X8238

FPC Detail
Scale:2/1

Dots Detail
Scale:50/1

VIEWING DIRECTION
320(R.G.B)x240 Dots

TITLE: LCD MODULE DRAWING